



# Towards to a new radiation damage model for Synopsys TCAD

Joern Schwandt

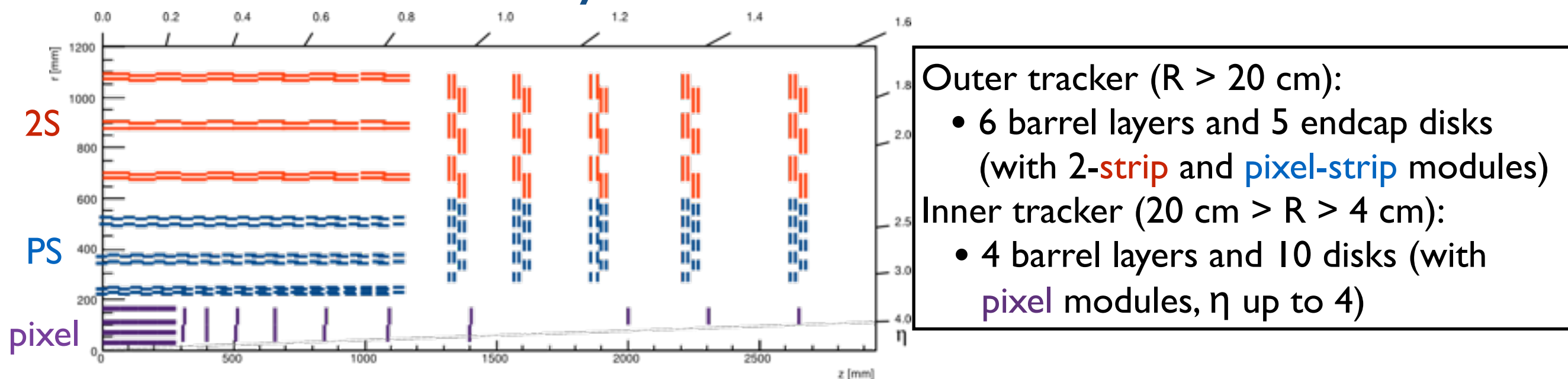
Institute for Experimental Physics  
University of Hamburg

27th RD50 Workshop  
December 2-4, 2015

## High-Luminosity LHC (~ 2024):

- Luminosity of  $5 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$ , operate up to 200 events/crossing
- Maintain occupancy at  $\approx 1\%$  level and increase the resolution
- ➔ Pixel size  $\sim 25 \times 100 \text{ } \mu\text{m}^2$  or  $50 \times 50 \text{ } \mu\text{m}^2$  (currently  $100 \times 150 \text{ } \mu\text{m}^2$ )

## CMS Tracker baseline layout:



## Radiation tolerance for the 1<sup>th</sup> pixel layer after 3000 fb<sup>-1</sup>:

- $\Phi_{\text{eq}} \approx 2 \times 10^{16} \text{ cm}^{-2}$ , Dose  $\approx 5 \text{ MGy}$

Pixel sensors (3D or thin planar) which can withstand these radiation fluence are needed

# Radiation damage

Optimization of the sensor → simulations

Simulations → device modeling (TCAD)  
+ models for bulk & surf. damage

**Bulk damage (NIEL):**

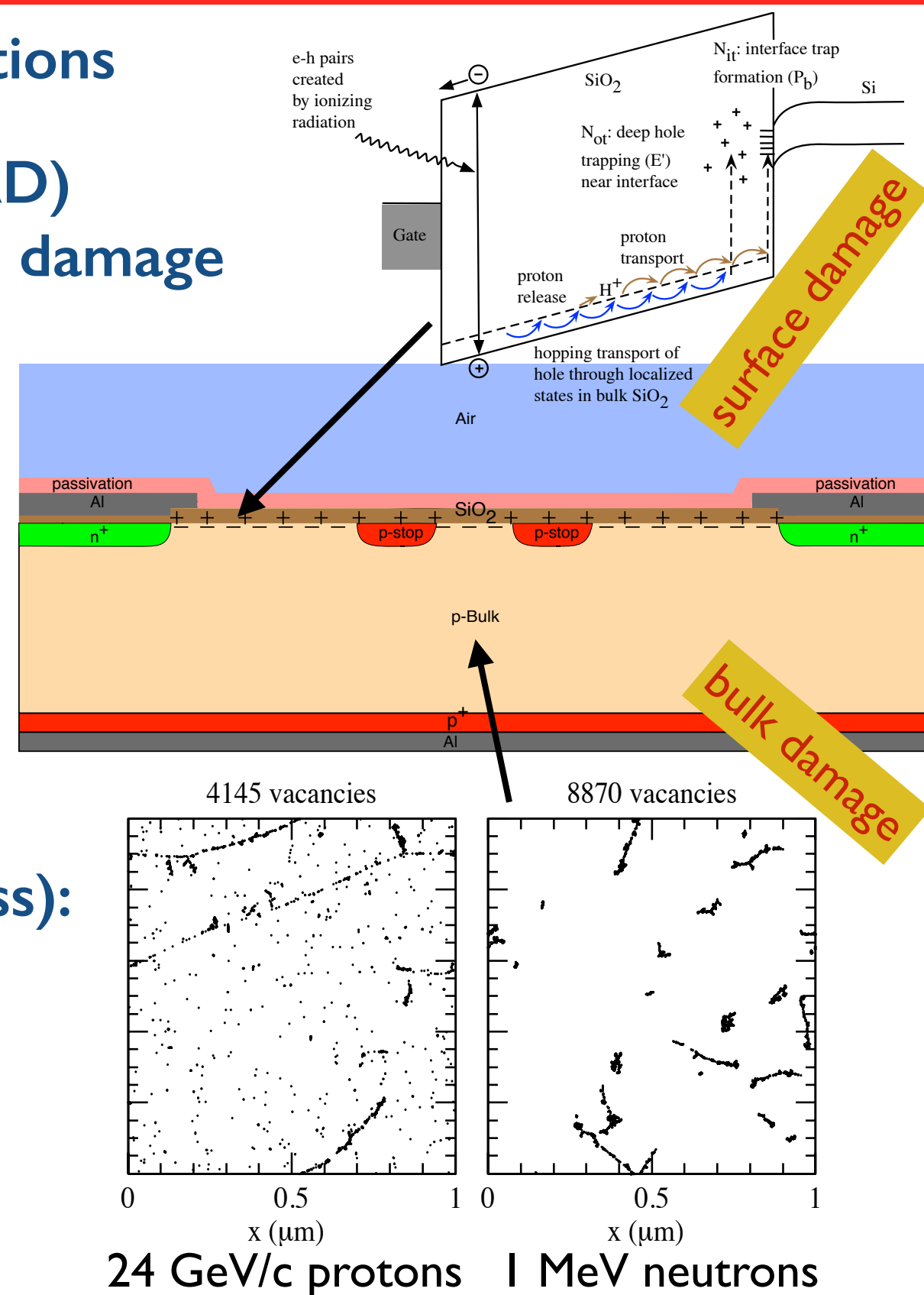
- Point and cluster defects
  - ➔ Increase of leakage current
  - ➔ Change of the space charge in the depletion region, increase of full depletion voltage
  - ➔ Charge trapping

**Surface damage\* (Ionizing Energy Loss):**

- ↑ Oxide charge & ↑ interface trap

**The models for bulk & surf. damage have to be correct (independently)**

\* In this talk, not further discussed





# Defect modeling approach

## Radiation damage depends on

- particle type, energy, annealing, silicon material + vendor (surface)

## It is measured on

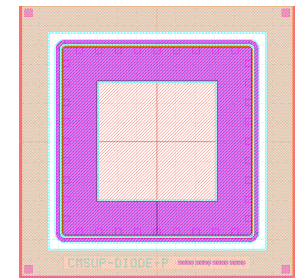
- diodes (bulk damage)
  - macroscopic (I-V, C-V, Transient Current Technique)
  - microscopic (Thermally Stimulated Current)
- special test structures (surface damage)
  - I-V, C/G-V and Thermally Dielectric Relaxation Current

## Validation of combined model on segmented sensor

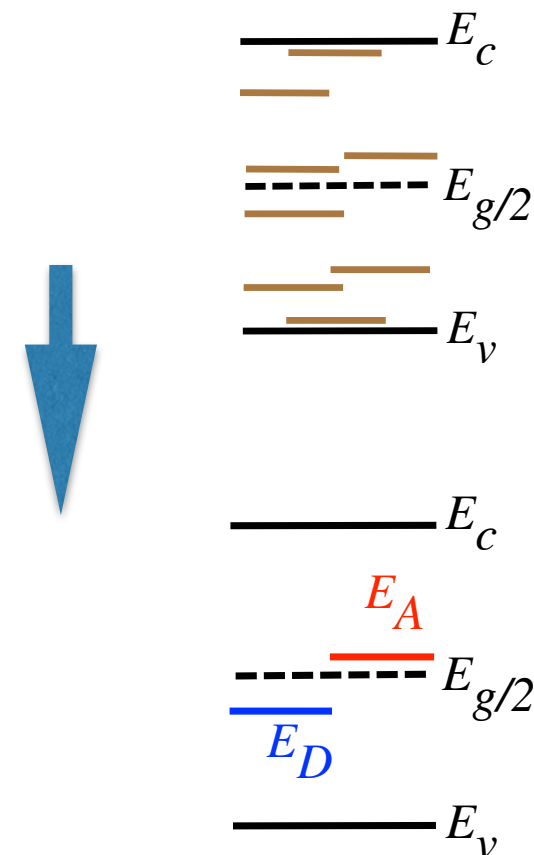
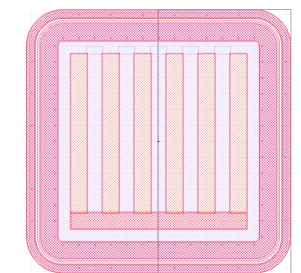
## Options for bulk damage modeling:

- Multi-trap model based on microscopic measurements
- Effective trap model tuned to macroscopic measurements e. g. Eremin 2-trap model

Diode



GCD



Acceptor (A)  
and donor (D)  
Energy levels  
fixed



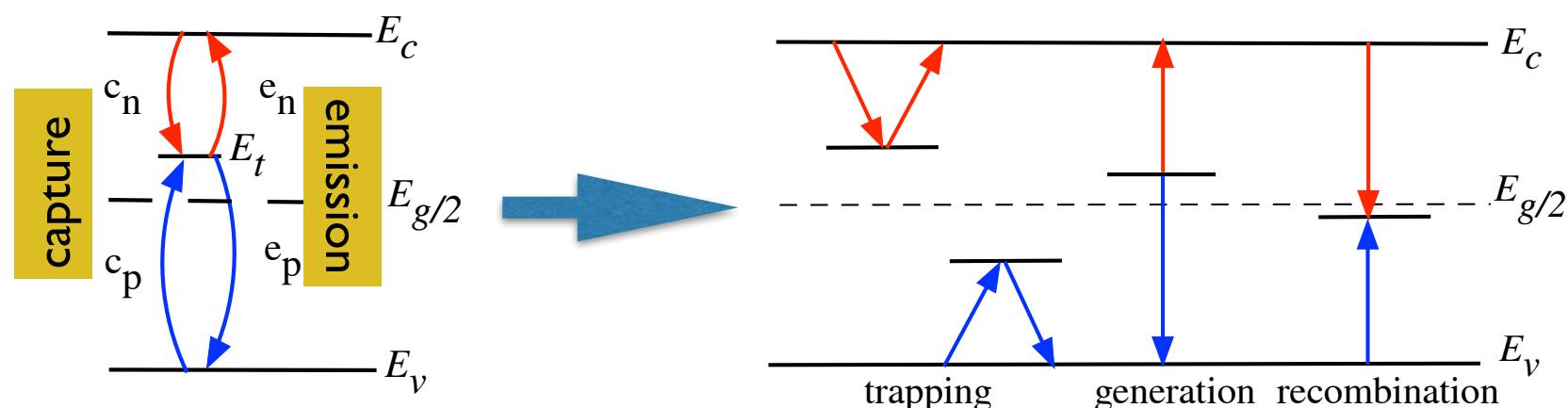
# Basics of effective 2-trap models I

- One **acceptor** (A) and one **donor** (D)
- **Energy levels fixed**

$E_A$	$E_D$
$E_C - 0.525 \text{ eV}$	$E_V + 0.48 \text{ eV}$

Traps obey Shockley-Read-Hall statistics:

(Eremin et al, NIMA 476 2002)



**2 trap model → 6 parameter**

1. Concentrations :  $N_A$  ,  $N_D$
2. Cross sections :  $\sigma_e^A$  ,  $\sigma_h^A$  ,  $\sigma_e^D$  ,  $\sigma_h^D$



# Basics of effective 2-trap models II

TCAD allows solving of device equations together with traps

**1. Poisson:**  $\nabla \cdot \epsilon \nabla V = -\rho_{eff}$  with  $\rho_{eff} = q[p - n + N_D f_D - N_A f_A] + \rho_{dopants}$

with  $f_D$  and  $f_A$  the occupied fractions given by SRH

**2. Continuity equations:**  $\frac{\partial n}{\partial t} = \frac{1}{q} \nabla \cdot J_n + R_{net}$  with  $J_n = qn\mu_n E + D_n \frac{dn}{dx}$

$$\frac{\partial p}{\partial t} = -\frac{1}{q} \nabla \cdot J_p + R_{net} \quad \text{with} \quad J_p = qp\mu_p E - D_p \frac{dp}{dx}$$

with  $R_{net}$  the net generation/recombination rate

Trapping is included and the effective trapping rates are given by the expressions:

$$\Gamma_e = v_e [\sigma_e^A N_A (1 - f_A) + \sigma_e^D N_D f_D] \approx v_e \sigma_e^A N_A \quad \text{approx. if } f_A \text{ and } f_D \text{ negligible}$$

$$\Gamma_h = v_h [\sigma_h^D N_D (1 - f_D) + \sigma_h^A N_A f_A] \approx v_h \sigma_h^D N_D$$

**Aim:**

- Simultaneous tuning of the 6 parameter to reproduce I-V, C-V and CCE with as simple as possible fluence dependence of parameters



# Existing bulk damage models

## Some available models:

1. 2-trap proton model (R. Eber Phd 2013): 23 MeV proton, 10min@60°C,  $\leq 10^{15}$  n<sub>eq</sub>/cm

Table 11.3: Two-Defect model for proton irradiation.

Parameter	Donor	Acceptor
Energy (eV)	$E_V + 0.48$	$E_C - 0.525$
Concentration (cm <sup>-3</sup> )	$5.598 \text{ cm}^{-1} \times F - 3.949 \cdot 10^{14}$	$1.189 \text{ cm}^{-1} \times F + 6.454 \cdot 10^{13}$
$\sigma(e)$ (cm <sup>2</sup> )	$1.0 \times 10^{-14}$	$1.0 \times 10^{-14}$
$\sigma(h)$ (cm <sup>2</sup> )	$1.0 \times 10^{-14}$	$1.0 \times 10^{-14}$

2. 3-trap Perugia model (D. Passeri IEEE TNS 2006):  $\leq 10^{15}$  n<sub>eq</sub>/cm<sup>2</sup>

Defect	E (eV)	$\sigma_e$ (cm <sup>-2</sup> )	$\sigma_n$ (cm <sup>-2</sup> )	$\eta$
Acceptor	$E_C - 0.42$	$1.00 \times 10^{-15}$	$1.00 \times 10^{-14}$	1.6
Acceptor	$E_C - 0.46$	$7.00 \times 10^{-15}$	$7.00 \times 10^{-14}$	0.9
Donor	$E_V + 0.36$	$3.23 \times 10^{-13}$	$3.23 \times 10^{-14}$	0.9

3. 2-trap proton model (Delhi, G. Jain NIMA 2015): 23 MeV proton, model for Silvaco TCAD

Damage	Trap type	Energy level (eV)	Density (cm <sup>-3</sup> )	$\sigma_e$ (cm <sup>-2</sup> )	$\sigma_h$ (cm <sup>-2</sup> )
Bulk	Acceptor	$E_C - 0.51$	$4 \times \phi$	$2.0 \times 10^{-14}$	$2.6 \times 10^{-14}$
Bulk	Donor	$E_V + 0.48$	$3 \times \phi$	$2.0 \times 10^{-14}$	$2.0 \times 10^{-14}$



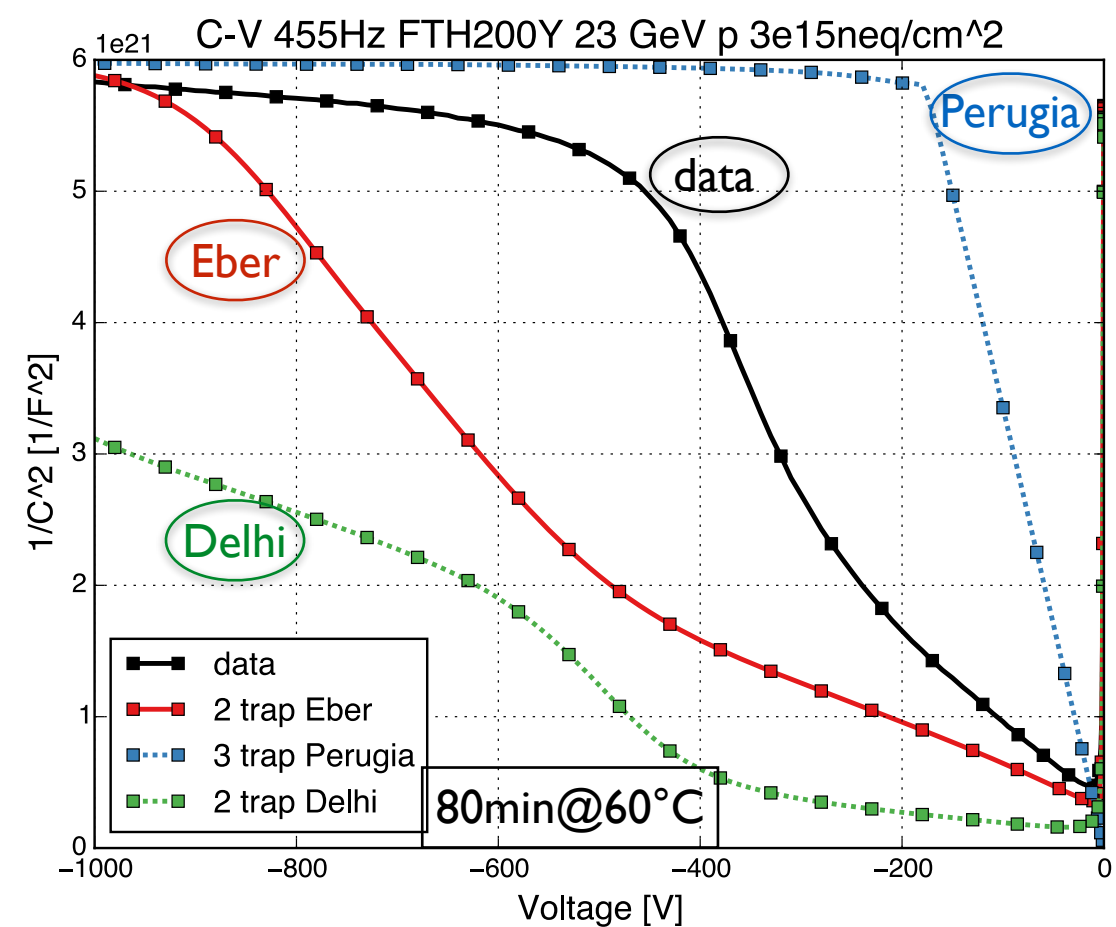
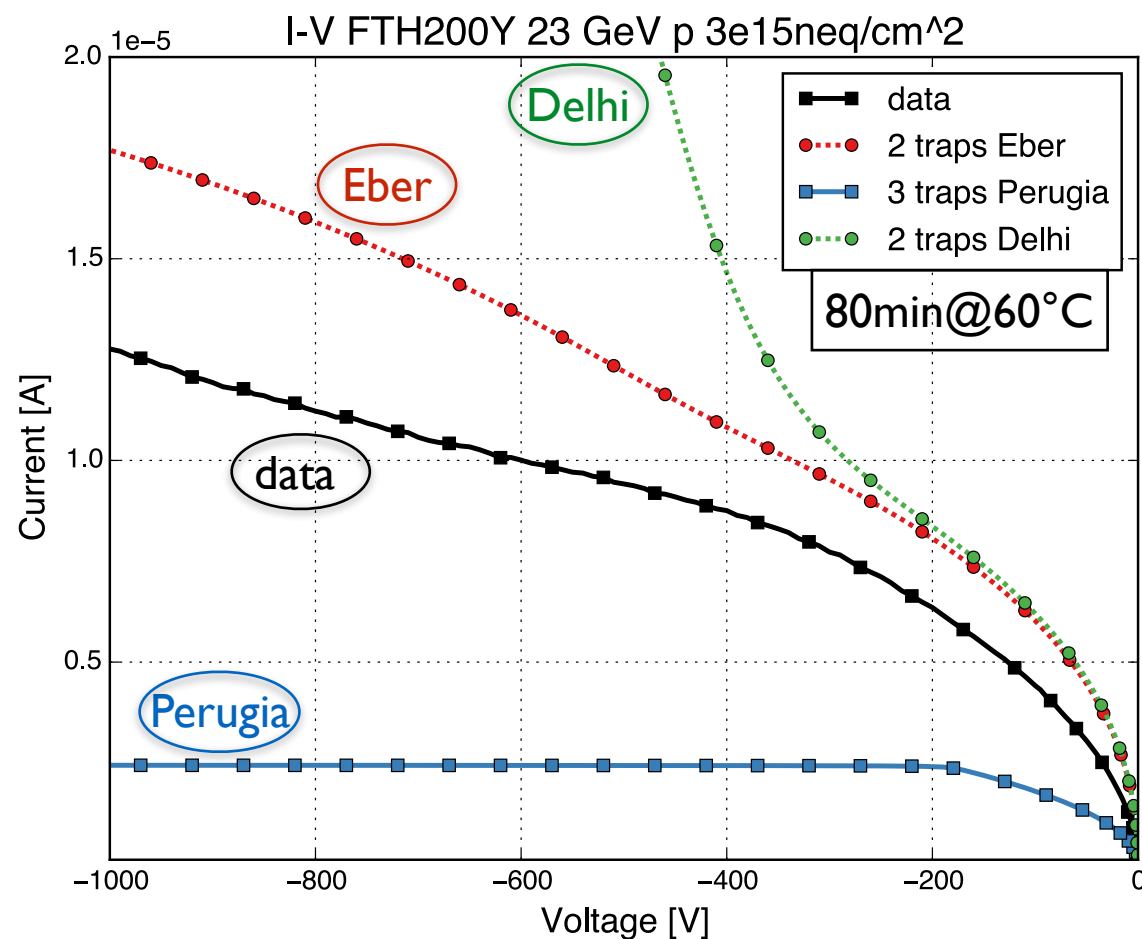
# Where do we stand?

## Why another bulk damage model?

- The current bulk models are limited in fluence ( $< 3 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ )
- Do not include annealing effects
- Are tuned to one specific material type & irradiation

## Examples:

- HPK diode, p-type, 200  $\mu\text{m}$  thick,  $T = -20^\circ\text{C}$



None of existing models matches 23 GeV p  $3 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$





# Toward to a new model

## First attempts for new effective damage model:

- Simulation of I-V and C-V of diodes for different fluences (HPK campaign) using the **optimizer** of TCAD for the determination of the 6 free parameters ( $\approx 3$  min/sim.) i.e. minimize the relative deviation between the simulations and measurements over a large voltage range or more precise: Minimize

$$F = w_1 \int_{V_{min}}^{V_{max}} \left(1 - \frac{I_{sim}}{I_{mes}}\right)^2 dV + w_2 \int_{V_{min}}^{V_{max}} \left(1 - \frac{C_{sim}}{C_{mes}}\right)^2 dV$$

with  $I_{sim}$  simulated current,  $I_{mes}$  measured current

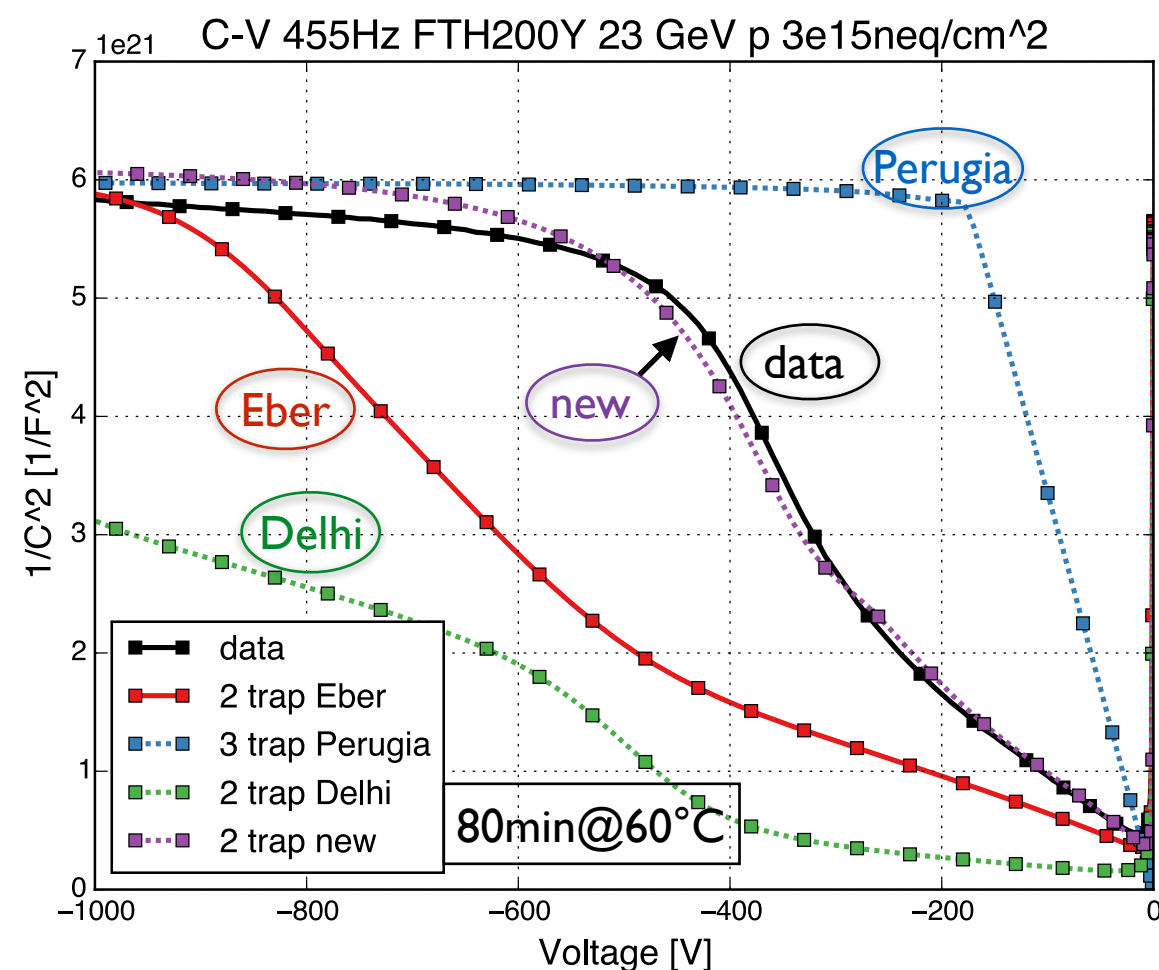
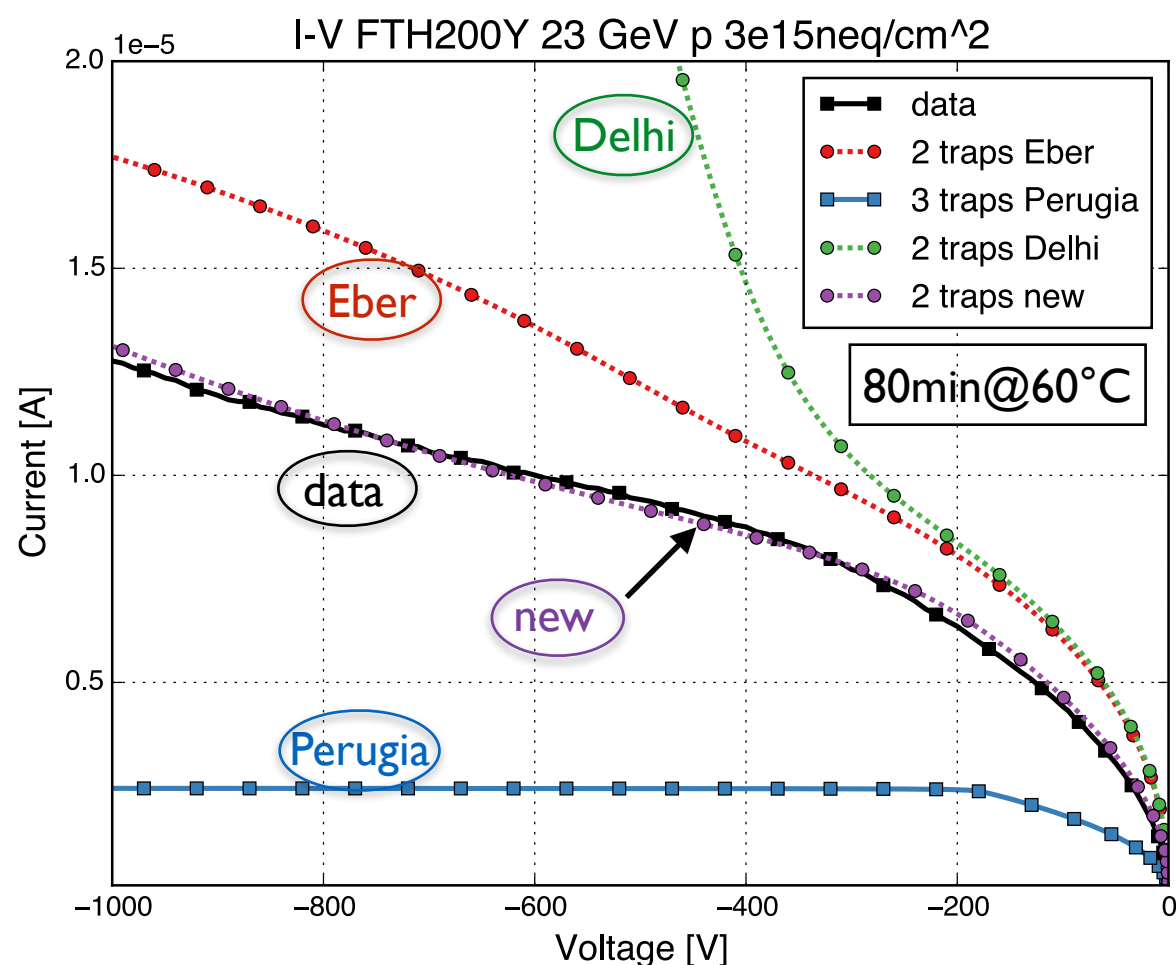
$C_{sim}$  simulated capacitance,  $C_{mes}$  measured capacitance

$V_{min}$ ,  $V_{max}$  min. and max of voltage range

$w_1$ ,  $w_2$  weighting factors

using for example an quasi-Newton methods.

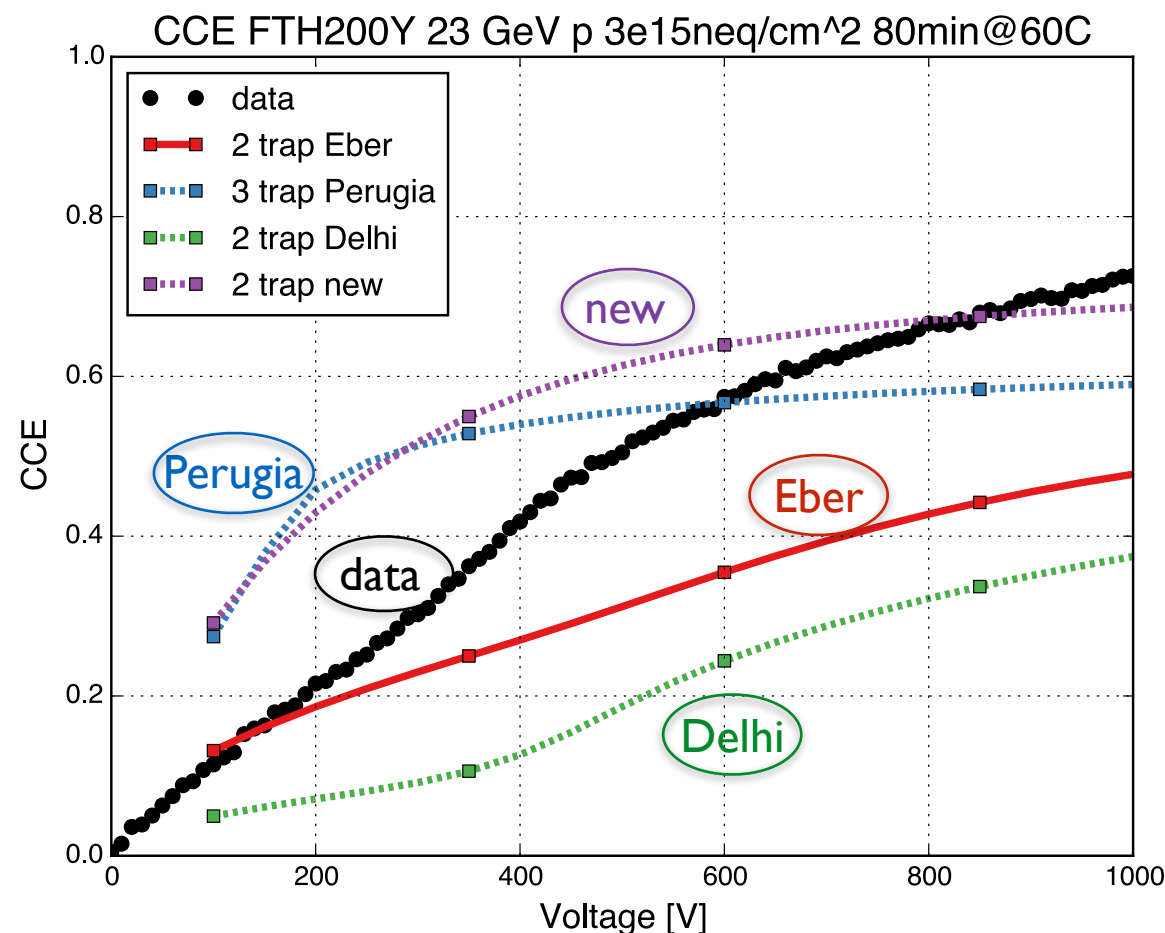
# First optimization results



Good match of I-V & C-V simultaneously

# TCT simulations (CCE)

## Check with CCE vs voltage for IR (1063nm) laser



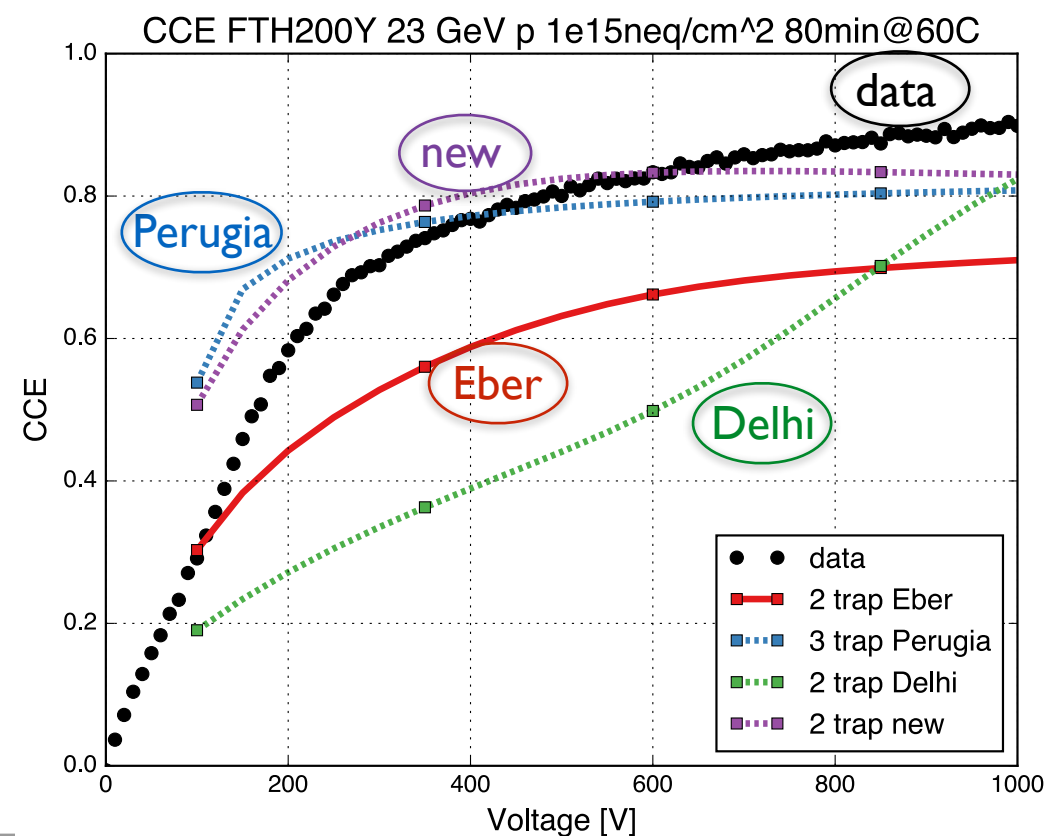
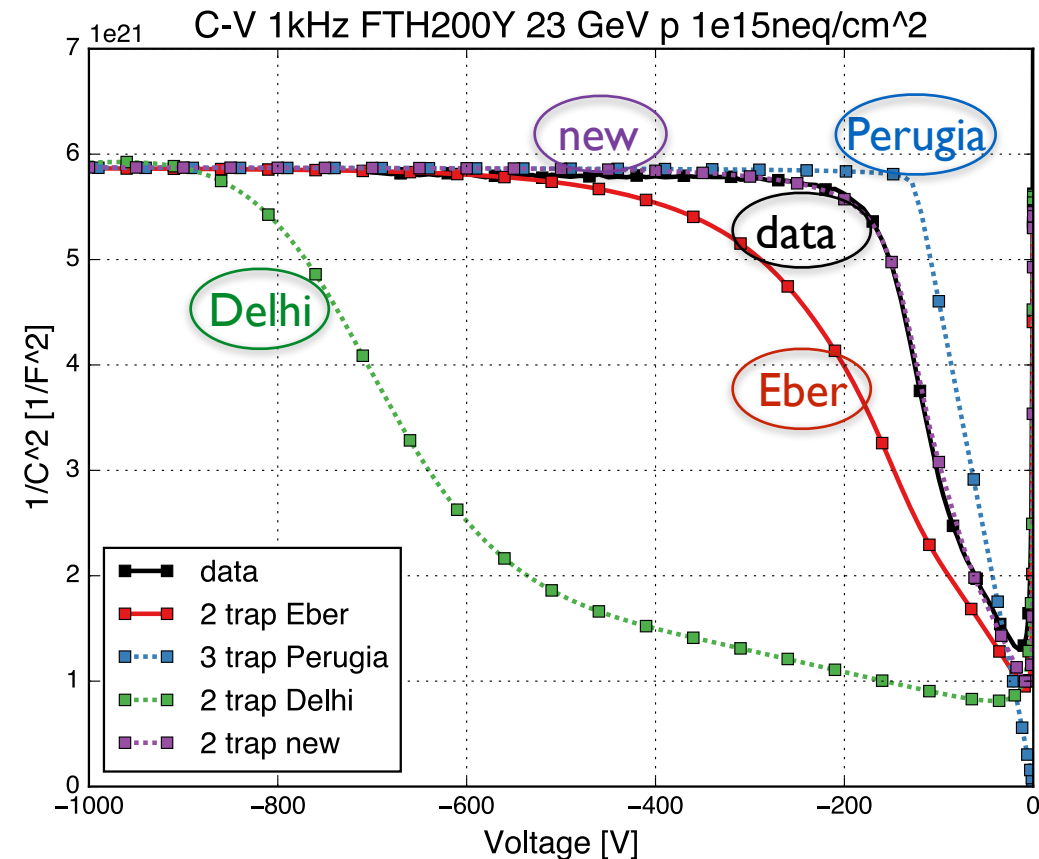
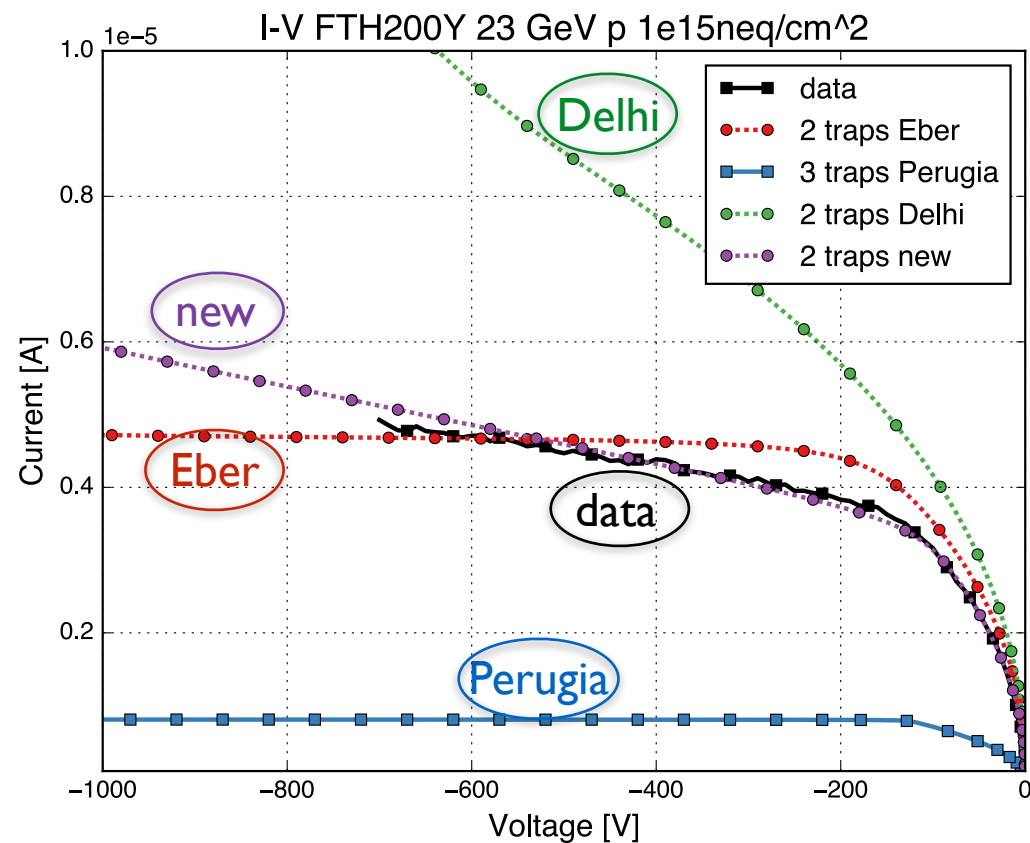
CCE simulation takes too long to be included in optimization procedure  
180 min/sim

- Models from Eber and Delhi results in too low CCE
- New fit gives too high CCE at low voltages

### Next step:

- Possibly include forward I-V to get constrain on recombination
- Are 2-traps sufficient for a consistent description at high fluences?

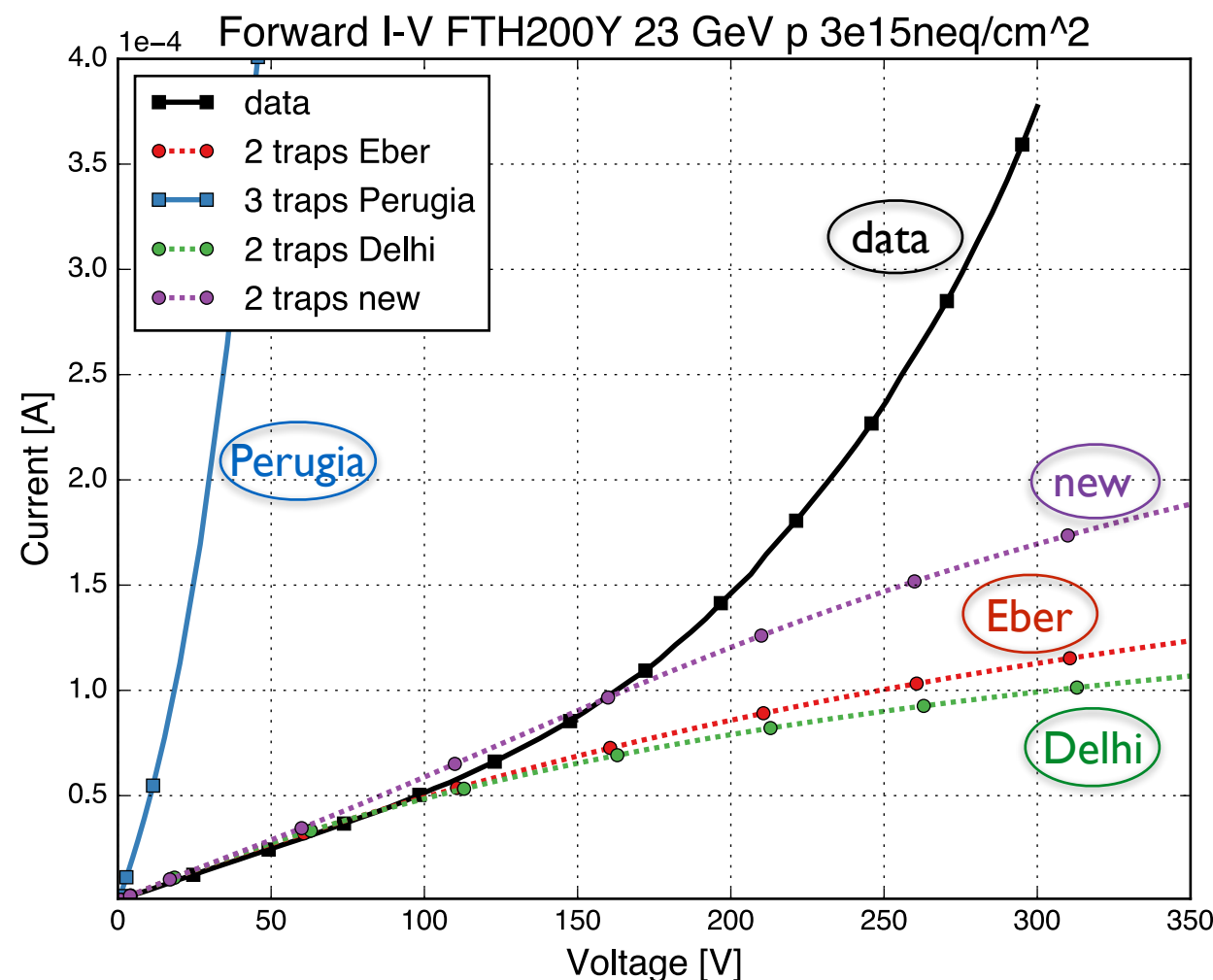
# Case: 23 GeV p $1 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$



Disagreement smaller in the case of  $1 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$

# Forward I-V for 23 GeV p $3 \cdot 10^{15}$ n<sub>eq</sub>/cm<sup>2</sup>

## Forward I-V measurement compared to simulations



None of the models reproduce the measured forward I-V

- Fit with I-V, C-V and forward I-V using the EVL 2-trap model doesn't converge 😞

### Next steps to test:

- Let the energy levels in the 2-trap model free (8 parameter) 😞
- 3-trap models (9 parameter or 12 parameter)



# Diodes: Irradiation plan

Data between  $3 \times 10^{15}$  and  $1.3 \times 10^{16} \text{ n}_{\text{eq}}/\text{cm}^2$  for model building needed

24GeV protons												
R/cm	10									5		
Φ/1e15	3	Large	Small	6	Large	Small	9	Large	Small	13	Large	Small
Epi100N		Epi100N_02_DiodeL_11	Epi100N_03_DiodeS_13		Epi100N_03_DiodeL_2	NO SAMPLES		Epi100N_02_DiodeL_3	NO SAMPLES		Epi100N_03_Diode_1	Epi100N_02_DiodeS_13
		Epi100N_03_DiodeL_11									Epi100N_03_Diode_2	Epi100N_03_DiodeS_14
Epi100Y		Epi100Y_02_Diode_1	Epi100Y_02_DiodeS_15		Epi100Y_02_DiodeL_3	Epi100Y_03_DiodeS_13		Epi100Y_04_DiodeL_3	Epi100Y_05_DiodeS_15		Epi100Y_03_Diode_1	Epi100Y_03_DiodeS_15
		Epi100Y_05_Diode_1									Epi100Y_03_Diode_2	
FZ120N		FZ120N_05_Diode_2	NO SAMPLES		FZ120N_05_DiodeL_9	NO SAMPLES		FZ120N_07_Diode_1	FZ120N_05_DiodeS_16		FZ120N_06_Diode_1	FZ120N_06_DiodeS_16
FZ120Y		FZ120Y_07_DiodeL_2	FZ120Y_03_DiodeS_16		FZ120Y_07_DiodeL_3	FZ120Y_06_DiodeS_16		FZ120Y_07_DiodeL_8	FZ120Y_07_DiodeS_13		FZ120Y_07_DiodeL_9	FZ120Y_07_DiodeS_14
FTH200N		FTH200N_24_Diode_2			FTH200N_04_Diode_2	FTH200N_02_DiodeS_14		FTH200N_06_Diode_1	FTH200N_02_DiodeS_16		FTH200N_25_Diode_2	FTH200N_04_DiodeS_14
FTH200P					FTH200P_03_DiodeL_5	FTH200P_01_DiodeS_14		FTH200P_03_DiodeL_9	FTH200P_01_DiodeS_16			
FTH200Y		FTH200Y_01_DiodeL_5	FTH200Y_02_DiodeS_16		NO SAMPLES	NO SAMPLES		NO SAMPLES	NO SAMPLES		FTH200Y_01_Diode_1	FTH200Y_03_DiodeS_16
MCZ200N		MCZ200N_04_DiodeL_8			NO SAMPLES	NO SAMPLES		NO SAMPLES	NO SAMPLES		MCZ200N_06_DiodeL_11	MCZ200N_06_DiodeS_14
											MCZ200N_09_DiodeL_11	
M200P			NO SAMPLES		MCZ200P_01_DiodeL_8	MCZ200P_03_DiodeS_13		MCZ200P_02_DiodeL_8	MCZ200P_02_DiodeS_13			
M200Y		MCZ200Y_04_Diode_2	MCZ200Y_03_DiodeS_13		NO SAMPLES	NO SAMPLES		NO SAMPLES	NO SAMPLES		MCZ200Y_04_DiodeL_9	MCZ200Y_05_DiodeS_15
FZ200N		NO SAMPLES	NO SAMPLES		NO SAMPLES	NO SAMPLES		NO SAMPLES	NO SAMPLES		NO SAMPLES	NO SAMPLES
FZ200Y		FZ200Y_02_DiodeL_11	FZ200Y_03_DiodeS_13		FZ200Y_03_Diode_1	FZ200Y_04_DiodeS_13		FZ200Y_05_DiodeL_11	FZ200Y_05_DiodeS_13		FZ200Y_06_DiodeL_11	FZ200Y_06_DiodeS_13
FZ320N		FZ320N_07_DiodeL_3	FZ320N_01_DiodeS_16		FZ320N_07_DiodeL_5	FZ320N_07_DiodeS_13		NO SAMPLES	FZ320N_07_DiodeS_14		NO SAMPLES	FZ320N_07_DiodeS_16
FZ320Y		FZ320Y_05_DiodeL_9	FZ320Y_04_DiodeS_13		FZ320Y_05_DiodeL_11	FZ320Y_05_DiodeS_16		FZ320Y_06_DiodeL_8	FZ320Y_06_DiodeS_13		FZ320Y_06_DiodeL_9	FZ320Y_06_DiodeS_16

Irradiation with 24 GeV/c p at the PS on the way

# Summary

1. It was shown that the available bulk damage models do not reproduce the data for high fluences
2. An attempt is made to develop a new model by fitting I-V and C-V measurements using the optimizer of TCAD
3. It seems that a 2-trap model is not able to describe I-V, C-V and CCE simultaneously
4. Diode irradiations with fluences  $3 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ ,  $6 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ ,  $9 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$  and  $1.3 \cdot 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$





# Backup

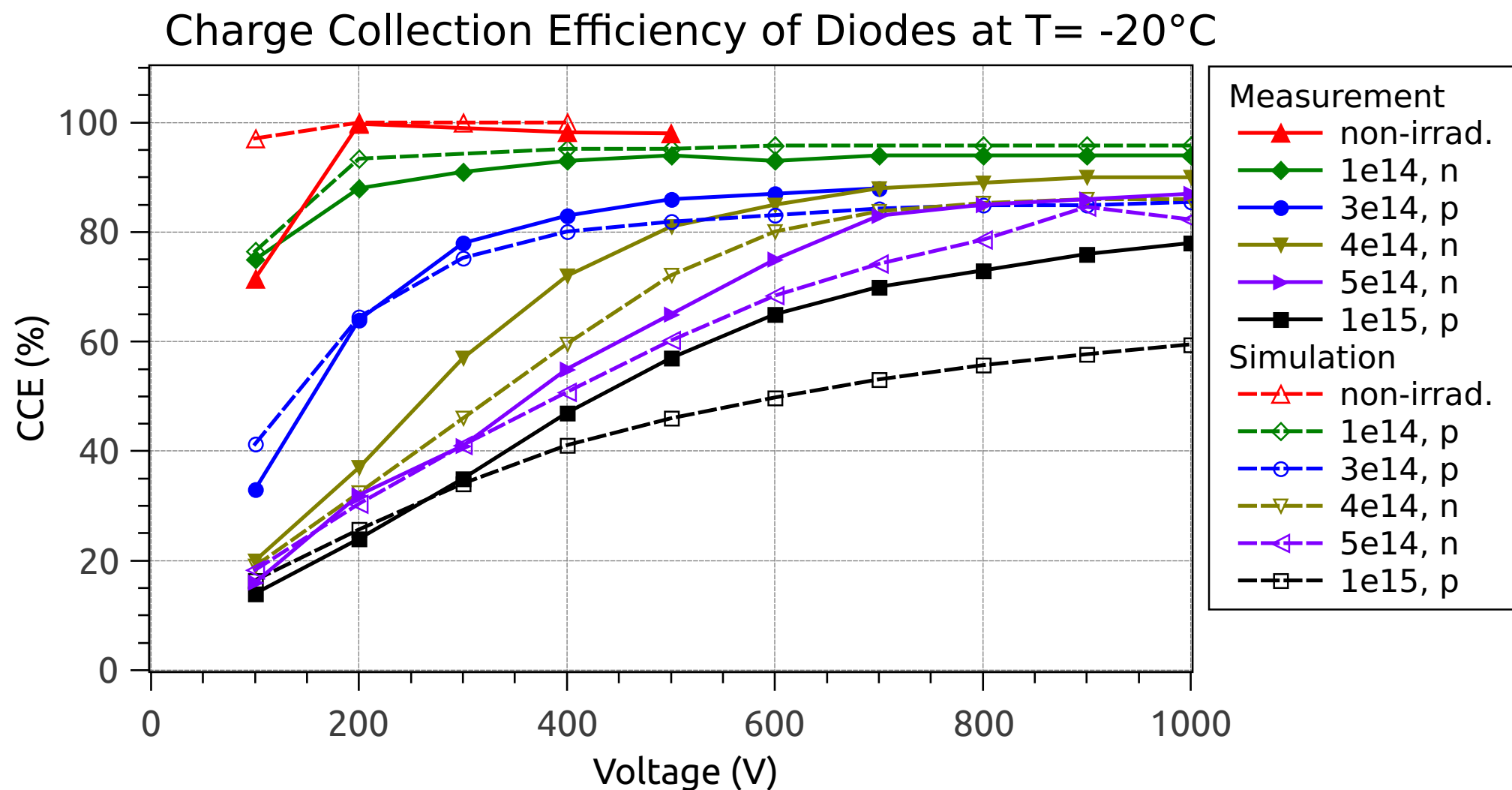


Figure 11.24: Charge collection efficiency of FZ320N diodes at T = -20 °C and several fluences (proton and neutron irradiation):  
*The CCE is simulated quite well, only at  $F = 10^{15} \text{ n}_{\text{eq}}\text{cm}^{-2}$  the measured CCE values are higher.*  
 Data partly from [Poe13].